

MICON 5 S, SMT low, 3 ± 0,6 N, 1 NO

COMING SOON



fields of application

- Measurement-control-regulation
- Mechanical and system engineering
- Automotive
- Electro-medical

special features

- Gold contacts, reliable switching with low currents
- Special tactile feedback
- High packing density due to small form factor (5.1 x 6.4 mm)
- Different operating forces
- Ring and full illumination of the button surface due to plunger
- Variable overall heights due to plunger
- Terminal technology: SMT
- Traceability through product identification in accordance with DIN EN ISO 9001



description

MICON 5 tactile switches offer extreme switching reliability, with a very small space requirement. They can be arranged individually, in rows or as key blocks. For use beneath overlays, we recommend combining the MICON 5 tactile switches with plungers. Here are the properties at a glance:

- Suitable for the most important soldering techniques
- Soldering bath for THT versions
- Reflow soldering for SMT versions
- Vapor phase soldering for SMT versions
- Manual soldering
- Processing of the SMT design with SMT automatic assembly machines
- IMDS entry

MICON 5, SMT nieder mit einer Bauhöhe von nur 3,45 mm Verarbeitungshinweis: Sonderpipette (Siemens Siplace Best.-Nr. 348514-02) Bestückung mit Revolverkopf. Vorschlag für Schablonendruck: 150 µm-Schablone mit 10% Pad-Verkleinerung auf Fläche

technical data

➤ general

Operating temperature, min.	-40 °C
Storage temperature, min.	-40 °C
Operating temperature, max.	125 °C
Storage temperature, max.	90 °C
illuminated	No
Soldering	Reflow

direct links

- RAFI eCatalog

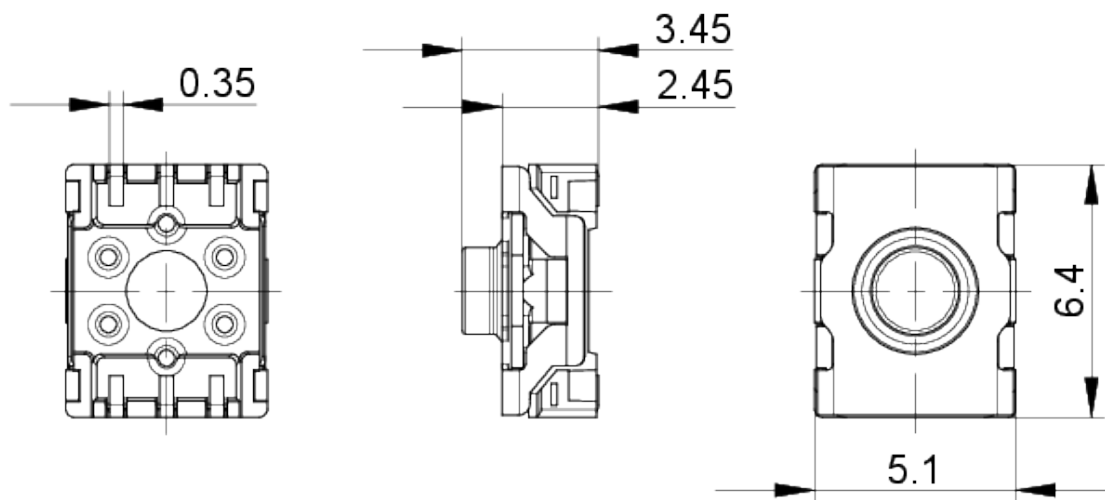
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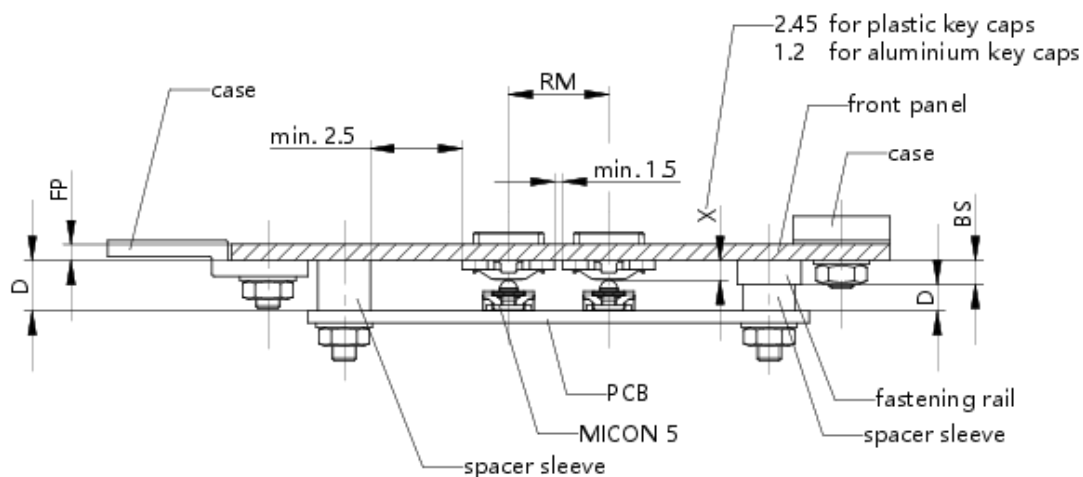
Solder heat resistance according to standard	DIN EN 60068-2-58
Packaging	DIN EN 61760-1
Packaging unit	Blister
Operating life	2,100 pcs.
B10	1,000,000 cycles
Degree of protection, front side, according to DIN EN 60529	1,300,000 cycles
Degree of protection, rear side, according to DIN EN 60529	IP54
MSL Moisture Sensitivity Level	IPx7
Shock resistance according to standard IEC 60068-2-27	IP54
oscillation resistance according to standard IEC 60068-2-6	IPx7
MOQ order	1
RoHS compliant	100 g at 6 ms amplitude semi-sinusoidal
REACH compliant	5 g at 10...500 Hz
Component material	2,100 pcs.
	Yes
	Yes
	Silicon
> mounting diameters	
Grid, min.	6 x 7,8 mm
Outside dimension, length	6.4 ± 0.1 mm
Outside dimension, width	5.1 ± 0.1 mm
> mechanical data	
Actuation function	momentary contact function
Operating force, max.	4 N
Operating force, min.	3 ± 0,6 N
Switching travel	0.6 ± 0.15 mm
Contact function	1 NO
Contact system	Snap-action contact
Contact material	Gold
Terminal on the rear	SMT
Solderability	Yes
> electrical data	
Rated voltage, min.	0.02 V
Rated voltage, max.	35 V
Dielectric strength	250 V
Rated current, min.	0.00001 A
Rated current, max.	0.1 A
Rated power, max.	1 W

drawings

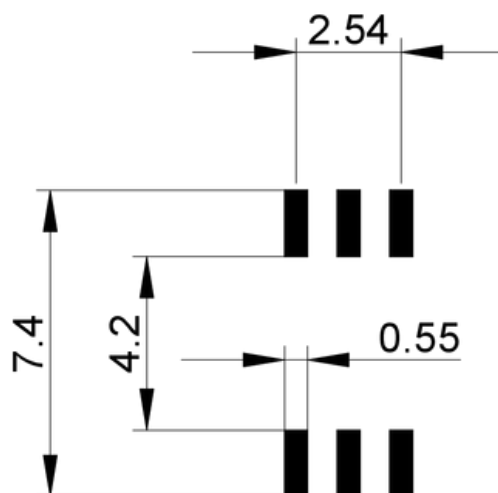
Dimensioned drawing



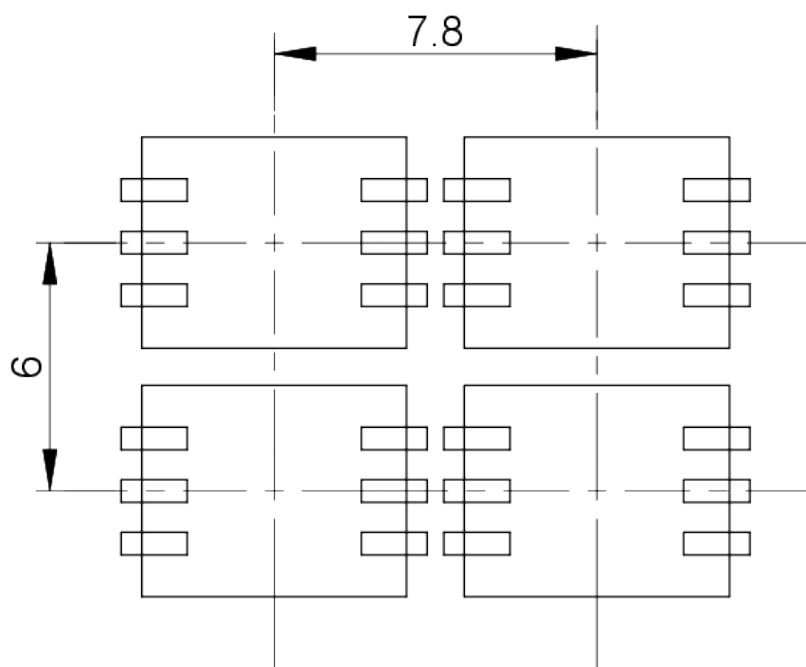
System drawing



PCB drawing

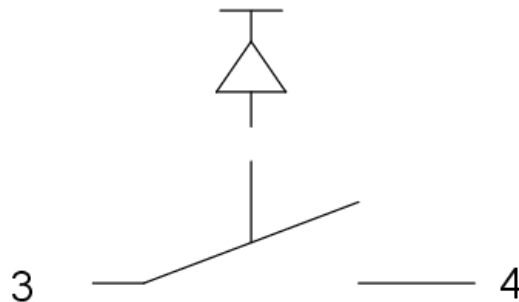
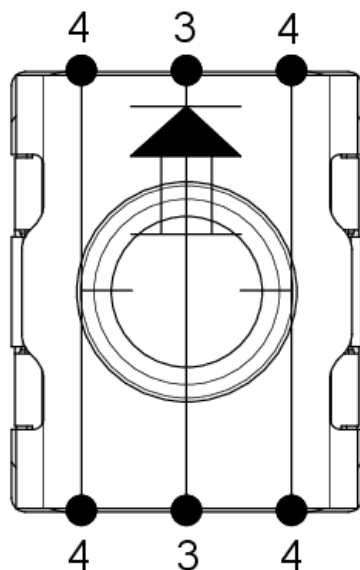


PCB drawing



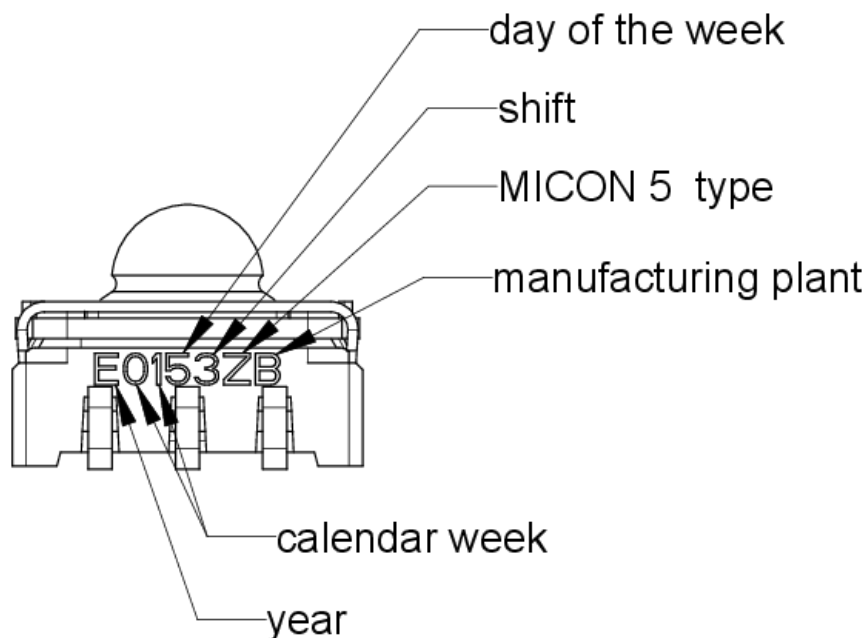
MICON 5 SMT

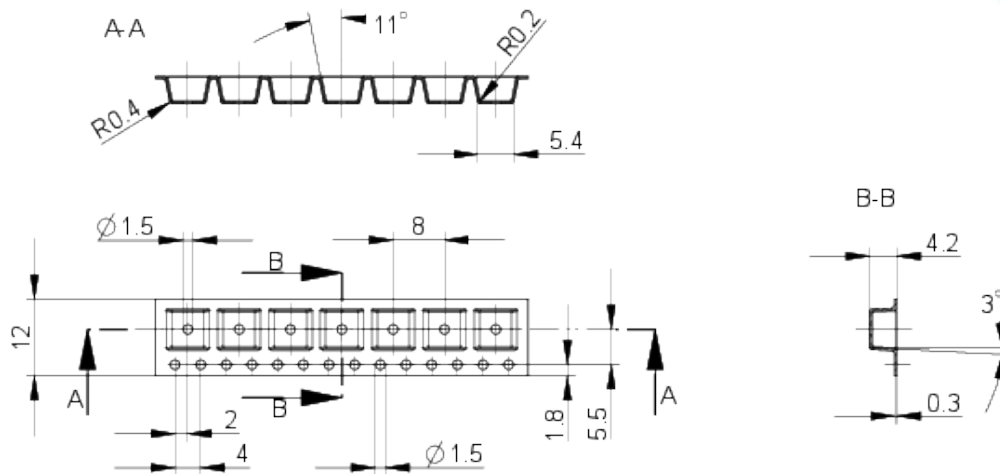
Schematic diagram



Circuit symbol according
to IEC 617

Product labeling drawing



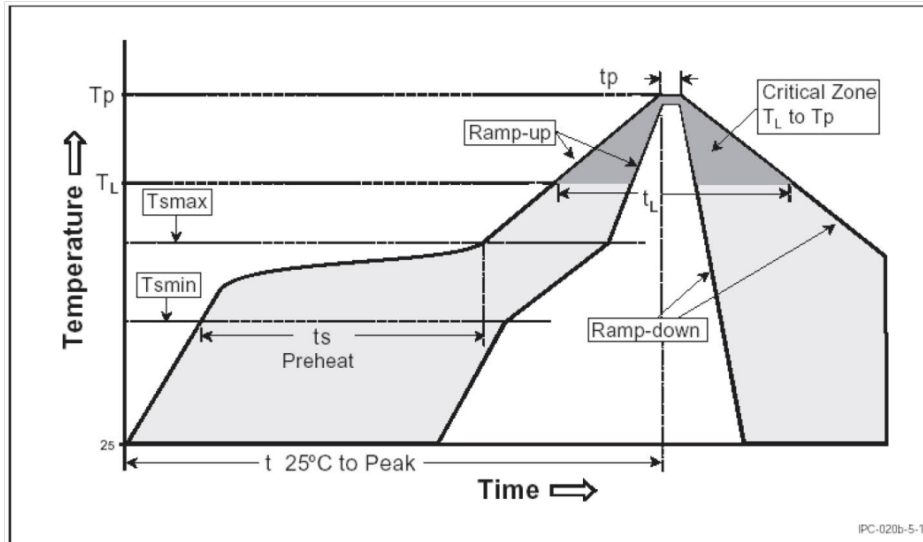
Packaging drawing

mounting

RAFI soldering profile for ROHS compliant reflow components

RAFI

Publication date: October 7, 2021



Parameter	RAFI values
Gradient (T_L to T_P)	max. 3°C / s
Preheating zone	
Minimum temperature (T_{smin})	150°C
Maximum temperature (T_{smax})	200°C
Time (from min. to max.) (t_s)	60 - 120 s
Gradient (T_{smax} to T_L)	max. 3°C / s
Time over melting temperature (T_L) time (t_L)	217°C 60 - 150 s
Peak temperature (T_P)	max. 260°C (+0°C)
Time within peak temperature – 5°C (t_p)	20-40 s
Gradient ramp down	max. 6°C / s
Time difference from 25°C to peak temperature	max. 8 minutes

The reflow soldering profile is based on the definition of Jedec J-STD-020D.

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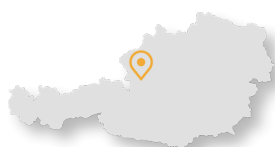
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